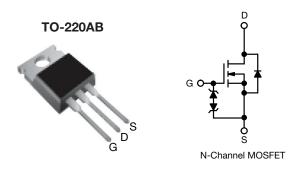
SiHP11N80AE

Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	850			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 \text{ V}$	0.391		
Q _g max. (nC)	42			
Q _{gs} (nC)	6			
Q _{gd} (nC)	12			
Configuration	Single			

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low effective capacitance (C_{iss})
- Reduced switching and conduction losses
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)
- Integrated Zener diode ESD protection
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy

ORDERING INFORMATION	
Package	TO-220AB
Lead (Pb)-free and halogen-free	SiHP11N80AE-GE3

ABSOLUTE MAXIMUM RATINGS	(T _C = 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V _{DS}	800	v
Gate-source voltage			V _{GS}	± 30	v
Continuous drain surrant $(T_{\rm e} = 150 ^{\circ}{\rm C})$	V _{GS} at 10 V	$T_{C} = 25 \text{ °C}$ $T_{C} = 100 \text{ °C}$		8	
Continuous drain current ($T_J = 150 \ ^\circ C$)	V _{GS} at 10 V	T _C = 100 °C	I _D	5	А
Pulsed drain current ^a			I _{DM}	22	
Linear derating factor				0.6	W/°C
Single pulse avalanche energy ^b			E _{AS}	88	mJ
Maximum power dissipation			PD	78	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope $T_J = 125 \text{ °C}$		dv/dt	70		
Reverse diode dv/dt ^d			2	V/ns	
Soldering recommendations (peak temperature	e) c	For 10 s		260	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 2.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 °C

S19-0956-Rev. A, 11-Nov-2019

Document Number: 92294



COMPLIANT

HALOGEN

FREE



THERMAL RESISTANCE RAT	INGS							
PARAMETER	SYMBOL	TYP.		MAX.	MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	-		62		°044		
Maximum junction-to-case (drain)	R _{thJC}	- 1.6			°C/W			
SPECIFICATIONS (T _J = 25 °C,	unless otherwi	se noted)						
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT
Static								
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μΑ	800	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	I _D = 1 mA	-	0.8	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 2	250 µA	2	-	4	V
Gate-source leakage Zero gate voltage drain current Drain-source on-state resistance	lasa	$V_{GS} = \pm 20 V$		-	-	± 10	μA	
	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$		-	-	± 50	μΑ	
rain-source on-state resistance		V _{DS} = 800 V, V _{GS} = 0 V		-	-	1		
Zero gale voltage ufam current	I _{DSS}	V _{DS} = 640 V	$V_{\rm GS} = 0$ V	′, T _J = 125 °C	-	-	10	μA
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	١ _c	₀ = 5.5 A	-	0.391	0.450	Ω
Forward transconductance ^a	9 _{fs}	V _{DS} =	= 30 V, I _D =	5.5 A	-	2.9	-	S
Dynamic		•			•			
Input capacitance	C _{iss}		V _{GS} = 0 V	_	-	804	-	
Output capacitance	C _{oss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz		-	34	-		
Reverse transfer capacitance	C _{rss}			-	5	-		
Effective output capacitance, energy related ^a	C _{o(er)}		(1. 400.)/		-	27	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}	- V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	162	-		
Total gate charge	Qg				-	28	42	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_{\rm D} = 5.5$	A, V _{DS} = 640 V	-	6	-	nC
Gate-drain charge	Q _{gd}				-	12	-	
Turn-on delay time	t _{d(on)}		•		-	13	26	
Rise time	t _r	V _{DD} =	640 V, I _D =	= 5.5 A,	-	15	30	
Turn-off delay time	t _{d(off)}		= 10 V, R _g =		-	25	50	ns
Fall time	t _f]			-	27	54	
Gate input resistance	R _g	f = 1	MHz, oper	n drain	0.7	1.5	3	Ω
Drain-Source Body Diode Characterist		•						
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	8		
Pulsed diode forward current	I _{SM}			-	-	22	A	
Diode forward voltage	V _{SD}	T _J = 25 °C	, I _S = 5.5 A	, V _{GS} = 0 V	-	-	1.2	V
Reverse recovery time	t _{rr}				-	278	556	ns
Reverse recovery charge	Q _{rr}	$T_{\rm J} = 25$	°C, I _F = I _S	= 5.5 A,	-	2.9	5.8	μC
Reverse recovery current	I _{RRM}	ai/at = 1	100 A/µs, \	$v_{\rm R} = 25 V$	-	17	-	A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 480 V V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

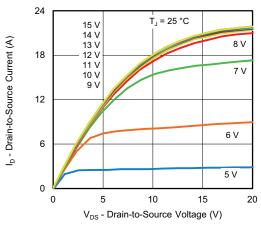


Fig. 1 - Typical Output Characteristics

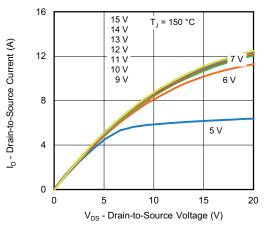


Fig. 2 - Typical Output Characteristics

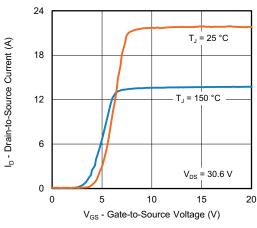


Fig. 3 - Typical Transfer Characteristics

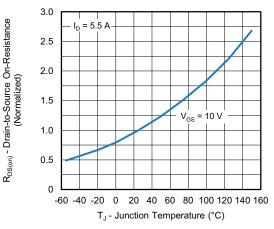


Fig. 4 - Normalized On-Resistance vs. Temperature

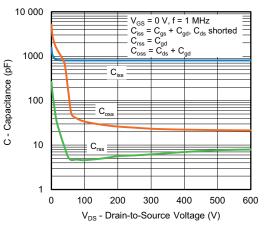
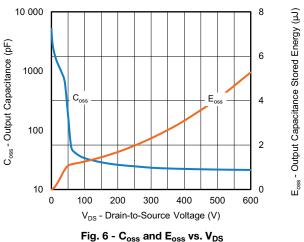


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S19-0956-Rev. A, 11-Nov-2019

3 For technical questions, contact: hvm@vishay.com Document Number: 92294

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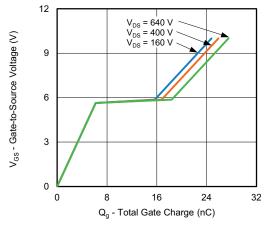


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

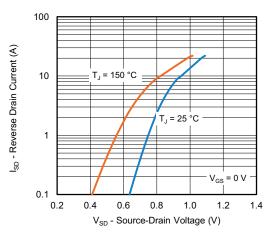


Fig. 8 - Typical Source-Drain Diode Forward Voltage

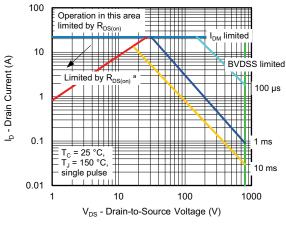


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

4

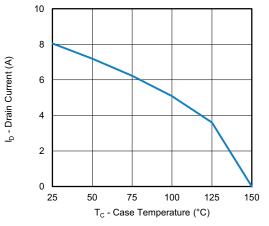


Fig. 10 - Maximum Drain Current vs. Case Temperature

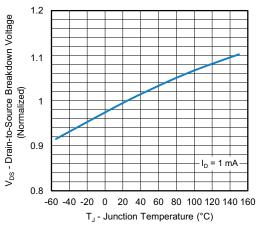
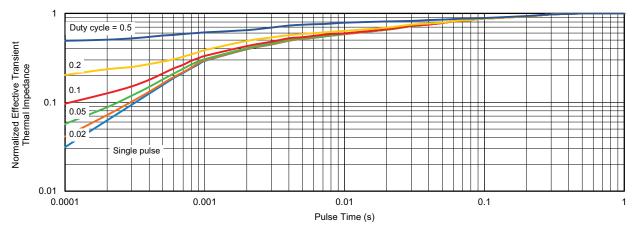


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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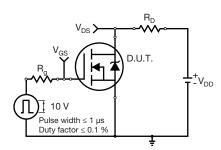


Fig. 13 - Switching Time Test Circuit

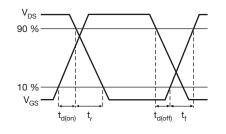


Fig. 14 - Switching Time Waveforms

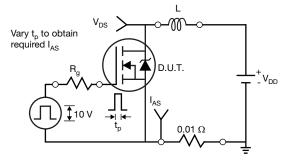


Fig. 15 - Unclamped Inductive Test Circuit

S19-0956-Rev. A, 11-Nov-2019

5

 V_{DD} V_{DS} I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

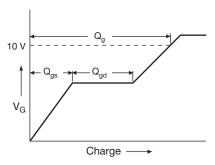
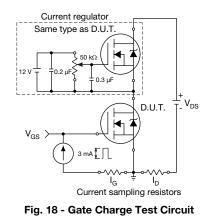


Fig. 17 - Basic Gate Charge Waveform



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Peak Diode Recovery dv/dt Test Circuit

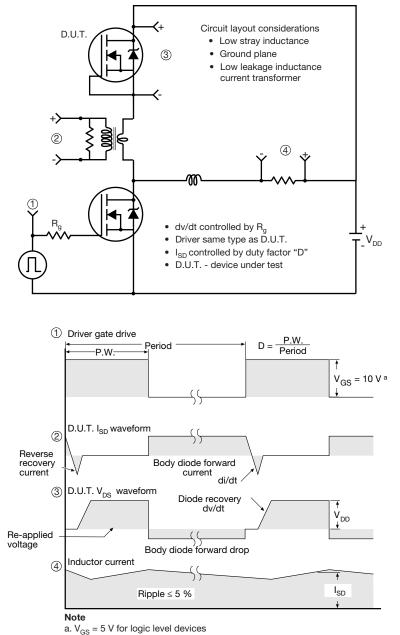


Fig. 19 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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